

## Lead free solder paste 500g, Sn96,5Ag3Cu0,5



- Solder paste NO-CLEAN
- Solder paste for stencil printing
- Grain size 3

Item no.	WL30137
Model	Pastentyp AP-40
Manufacturer	TAMURA ELSOLD
Manufacturer article no.	LOTPAST0051
GPSR manufacturer data	TAMURA DEUTSCHLAND GmbH Hüttenstraße 1 DE-38871 Ilseburg www.tamura-elsold.de
Sales unit	1 cans

Products for the electronic industry



Content unit	500 g
Detail content unit	500 g
Incl. battery	no
Classification	DIN EN61190-1-1 RELO
Alloy	Sn96,5Ag3Cu0,5
Lead-free/lead-containing	lead free
Metal content	88 %
Metal powder size	25 – 45 µm

